

**MURI on “The Effects of High
Power Microwaves and Chaos in 21st
Century Analog and Digital Circuits”
(Administered by AFOSR)**

**Introduction to Presentations by
University of Maryland, College Park (UMCP)
and Boise State University (BSU)**

“Overview of Research Progress”

presented by Victor L. Granatstein

Third Annual Review 10/23/04

MAIN TOPICS

- A. Using wave chaos concepts to predict statistically wave coupling into complex RF enclosures.**
- B. EM noise mitigation in circuit boards and cavities**
- C. RF effects on semiconductor devices, circuits and systems**
 - (a) Modeling from basic equations of physics**
 - (b) Experimental studies of chaos and nonlinear RF effects in high speed circuits and digital systems**
- D. Boise State Univ. studies of gate oxide stress**

A. Wave Chaos : Overview

FACULTY: Steven Anlage, Thomas M. Antonsen Jr., Edward Ott

GRAD STUDENTS: James Hart, Sameer Hemmady, X. Henry Zheng

- **Model gives statistical ensemble of scattering matrices describing coupling into and out of irregular enclosures (Random Coupling Model)**
- **RCM requires only generic input parameters (e.g., cavity Q & impedance of ports)**
- **Predictions of RCM verified in microwave cavity with “chaotic” ray paths (1/4 bow tie cavity)**
- **Revolutionary new way to predict statistical properties of microwave fields in irregular enclosures.**

A. Wave Chaos: Interactions/Transitions

- **Ongoing interaction with NRL groups studying nonlinear circuit response and RF effects**
- **Participation in Ad-hoc DOD Working Group on Nonlinear & Chaotic Effects (UMCP hosted meeting and presented wave chaos work there)**
- **2 journal papers (Phys. Rev. E & IEEE Trans. CS)
4 papers submitted (Phys. Rev. Lett., Electromagnetics)
1 paper in conference proceedings
Talks at DEPS, EUROEM, APS, UNM. Site visits by AFRL
T. Antonsen received Faculty Outstanding Research Award**

B. EM Noise Mitigation: Overview

FACULTY: Omar Ramahi

CURRENT GRAD STUDENTS: S. Shaparia, M. Kerman

STUDENTS GRADUATED: B. Mohajer-Iravani (M.S.)

Lin Li (PH.D.), Xin Wu (Ph.D.)

- **Developed new concept for noise mitigation in circuit boards using high impedance surfaces (electromagnetic band gap material)**
- **Developed new aperture coating technique that substantially reduces aperture induced resonance**

B. EM Noise Mitigation: Interactions/Transitions

- **Invited presentations at IBM (Res.Triangle Pk., NC), Sun Microsystems. (Burlington, MA), Hewlett Packard (Marlborough, MA), Inco Corp (Toronto, Can) & E-tenna (Laurel, MD)**
- **4 papers published in refereed journals
11 papers in conference proceedings**
- **Excellent Paper Award at EMCD '04**

C. RF Effects on Semiconductor Devices, Circuits and Systems: Overview

FACULTY: Victor Granatstein, Neil Goldsman, Agis Iliadis, Bruce Jacob,
John Melngailis, John Rodgers

GRAD STUDENTS: Vincent Chan, Cagdas Dirik, Todd Firestone,
Woochul Jeon, Kyechong Kim, Laise Parker, Bo Yang

- **Simulated EM effects in devices, gates and interconnects; provides input parameters for SPICE based on physics eqs. instead of measurements on existing devices.**
- **Identified major mechanism for RF upset of ICs ; viz., ESD devices demodulate RF and induced voltages cause bias shift, bit errors, latch, oscillations, noise, etc.; spurious resonances can amplify induced voltages**
- **Improved on-chip microwave sensors; e.g. Schottky diode compatible with CMOS operating at 15 GHz**

C. Microwave Effects on Devices & Circuits Interactions/Transitions

- **Interaction with Lab of Physical Sciences (NSA) to develop 3-dimensional models of ICs**
- **Working with ARL to simulate details of wide bandgap semiconductor device operation**
- **Provided Titan-Jaycor with num. & exper. data on RF characteristics of wide range of device families; used to benchmark code for predicting RF effects in DOD systems**
- **Inst. of Defense Analysis funded study of data recovery using RF probing of smart card chips**
- **2 papers published and 2 papers submitted to refereed journals, 8 papers in conference proceedings**
- **Patent pending “Sense and Protect Circuit”, #MR2833-15**

Research at Boise State University

FACULTY: R. Jacob Baker, William B. Knowlton,
(6 grad students incl. 1 MS completed)

- **Collaboration with J. Melngailis on CMOS compatible Schottky diode**
- **Demonstrated significant degradation in MOSFET and inverter circuit operation resulting from gate oxide pulsed stress**
- **Cooperation with Micron Technology, Cypress Semiconductor and International SEMATECH (Austin, TX)**
- **6 papers in conference proceedings**

Presentations

PART A. WAVE CHAOS

2. Wave Chaos Theory: “Statistical Properties of Wave Chaotic Scattering & Impedance Matrices”

----- Presenter: Tom Antonsen

3. Wave Chaos Experiments: “Universal Field, Impedance and S-Matrix Statistics of Metallic Enclosures”

----- Presenter: Steve Anlage

PART B. RF INTERFERENCE MITIGATION

4. “EM Noise Mitigation in Circuit Boards and Cavities”

----- Presenter: Omar Ramahi

Presentations

PART C. RF EFFECTS on DEVICES & CKTS.

5. “On-Chip Schottky Diodes and MOSFET RF-Detectors and Focused Ion Beam Post-Processing”

----- Presenter John Melngailis

6. “Experimental Investigation of Microwave Vulnerabilities in CMOS Inverters”

----- Presenter: Agis Iliadis

7. “Modeling EM Effects on Semiconductor Devices, Gates & IC Interconnects”

----- Presenter: Neil Goldman

Presentations

8. “ Studies of RF Upset and Nonlinear Effects in Circuits” ----- Presenter: John Rodgers
9. “RF Interference and Circuit Integrity in Digital Systems’ ----- Presenter: Bruce Jacob

D. RESEARCH at BOISE STATE UNIVERSITY

10. “Degradation in Gate Oxides: Experimental Studies of Stress in Devices and Circuits” ----- Presenter: Bill Knowlton